DIAMOND COMPOUND

Die Quip's line of diamond compounds are specially formulated for use in the mold and die industries. They will withstand severe polishing conditions without loss of cutting quality. The use of a stable carrier assures diamond particals stay in suspension throughout the cutting cycle. The quality and design of our carrier is not affected by frictional heat generated during polishing. This keeps the diamond compound in the working area for faster cutting speeds and less compound needed per cut.



FORMULA 602

Our original oil-based formula that provides faster cutting action with its diamond concentration and self lubricating properties. It is best used in hand polishing, ripping and traditional lapping operations where fast material removal is important.

FORMULA 608

608's unique blend provides more surface coverage and impregnation of lapping tools. Its fast cutting rate is best used in hand polishing, ripping and traditional lapping operations where fast material removal is important. The large packaging of 608 is designed to reduce the cost of heavily concentrated compounds while retaining the quality you expect.

ORDERING INFORMATION

602 009 00

Package type - 00 = 5gm jar, 01 = 5gm gun, 02 = 18gm gun (608 packaging - 00 = 25gm jar, 01 = 20gm gun)

Grade number - use 0005 = #1/2, 003 - #3, 230 = #230, ect.

GRADE CHART

Micron	Color
Size	Code
0-1	Grey
0-2	lvory
2-4	Yellow
4-8	Orange
8-12	Green
12-22	Blue
22-36	Red
36-54	Brown
54-80	White
230 Mesh	Purple
	Size 0-1 0-2 2-4 4-8 8-12 12-22 22-36 36-54 54-80

FORMULA 605

Formula 605 is an oil-based compound specifically designed to provides superior mirror finishes. It is intended to follow grinding operations or to remove light wear economically while generating better surface finishes.

FORMULA 615

Use formula 615 where contamination from oil or solvents cannot be tolerated. 615 is water soluable and cleans up with mild-detergent and water. It is based on our 605 formula with the cutting action is slightly slower than that of the 605.

DIE QUIP CORP.

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Formula Number - 602, 605, 615, 608